

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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# RGT50TS65D

### 650V 25A Field Stop Trench IGBT

V <sub>CES</sub>	650V
I <sub>C(100°C)</sub>	25A
V <sub>CE(sat) (Typ.)</sub>	1.65V
$P_D$	174W

#### Features

- 1) Low Collector Emitter Saturation Voltage
- 2) Low Switching Loss
- 3) Short Circuit Withstand Time 5µs
- 4) Built in Very Fast & Soft Recovery FRD (RFN - Series)
- 5) Pb free Lead Plating; RoHS Compliant

### Applications

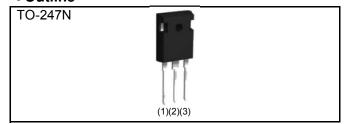
**General Inverter** 

**UPS** 

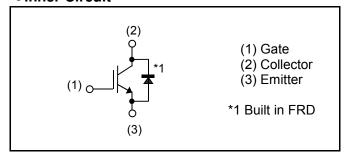
**Power Conditioner** 

Welder

#### Outline



### ●Inner Circuit



### Packaging Specifications

	Packaging	Tube
	Reel Size (mm)	-
Typo	Tape Width (mm)	-
Туре	Basic Ordering Unit (pcs)	450
	Packing code	C11
	Marking	RGT50TS65D

## ● Absolute Maximum Ratings (at T<sub>C</sub> = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit	
Collector - Emitter Voltage		$V_{CES}$	650	V	
Gate - Emitter Voltage		$V_{GES}$	±30	V	
Collector Current	T <sub>C</sub> = 25°C	I <sub>C</sub>	48	А	
Collector Current	T <sub>C</sub> = 100°C	I <sub>C</sub>	25	А	
Pulsed Collector Current	I <sub>CP</sub> *1	I <sub>CP</sub> *1 75			
Diode Forward Current	T <sub>C</sub> = 25°C	l <sub>F</sub>	35	А	
Diode Forward Current	T <sub>C</sub> = 100°C	l <sub>F</sub>	20	А	
Diode Pulsed Forward Current		I <sub>FP</sub> *1	75	А	
T <sub>C</sub> = 25°C		P <sub>D</sub>	174	W	
Power Dissipation	T <sub>C</sub> = 100°C	P <sub>D</sub>	87	W	
Operating Junction Temperature		T <sub>j</sub>	-40 to +175	°C	
Storage Temperature		T <sub>stg</sub>	-55 to +175	°C	

<sup>\*1</sup> Pulse width limited by T<sub>jmax.</sub>

### ●Thermal Resistance

Darameter	Symbol	Values			Linit
Parameter		Min.	Тур.	Max.	Unit
Thermal Resistance IGBT Junction - Case	$R_{\theta(j-c)}$	-	ı	0.86	°C/W
Thermal Resistance Diode Junction - Case	$R_{\theta(j-c)}$	-	1	2.28	°C/W

# ullet IGBT Electrical Characteristics (at $T_j$ = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
r ai ainetei	Syllibol	Conditions	Min.	Min. Typ. Max.		Offic
Collector - Emitter Breakdown Voltage	BV <sub>CES</sub>	$I_{C} = 10 \mu A, V_{GE} = 0 V$	650	1	1	V
Collector Cut - off Current	I <sub>CES</sub>	V <sub>CE</sub> = 650V, V <sub>GE</sub> = 0V	1	1	10	μΑ
Gate - Emitter Leakage Current	I <sub>GES</sub>	$V_{GE} = \pm 30V, V_{CE} = 0V$	1	-	±200	nA
Gate - Emitter Threshold Voltage	$V_{GE(th)}$	V <sub>CE</sub> = 5V, I <sub>C</sub> = 17.5mA	5.0	6.0	7.0	V
Collector - Emitter Saturation Voltage	V <sub>CE(sat)</sub>	$I_C = 25A, V_{GE} = 15V$ $T_j = 25^{\circ}C$ $T_j = 175^{\circ}C$	-	1.65 2.15	2.1 -	V

# ●IGBT Electrical Characteristics (at T<sub>j</sub> = 25°C unless otherwise specified)

Darameter	Symbol	mbol Conditions		Values		
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Input Capacitance	C <sub>ies</sub>	V <sub>CE</sub> = 30V	-	1400	-	
Output Capacitance	C <sub>oes</sub>	V <sub>GE</sub> = 0V	-	56	-	pF
Reverse Transfer Capacitance	C <sub>res</sub>	f = 1MHz	-	22	-	
Total Gate Charge	Q <sub>g</sub>	V <sub>CE</sub> = 300V	-	49	-	
Gate - Emitter Charge	$Q_{ge}$	I <sub>C</sub> = 25A	-	15	-	nC
Gate - Collector Charge	$Q_{gc}$	V <sub>GE</sub> = 15V	-	19	-	
Turn - on Delay Time	t <sub>d(on)</sub>	I <sub>C</sub> = 25A, V <sub>CC</sub> = 400V	-	27	-	
Rise Time	t <sub>r</sub>	$V_{GE} = 15V, R_G = 10\Omega$	-	32	-	
Turn - off Delay Time	$t_{d(off)}$	T <sub>j</sub> = 25°C	-	88	-	ns
Fall Time	t <sub>f</sub>	Inductive Load	-	65	-	
Turn - on Delay Time	t <sub>d(on)</sub>	I <sub>C</sub> = 25A, V <sub>CC</sub> = 400V	-	28	-	
Rise Time	t <sub>r</sub>	$V_{GE} = 15V, R_{G} = 10\Omega$	-	37	-	20
Turn - off Delay Time	t <sub>d(off)</sub>	T <sub>j</sub> = 175°C	-	100	-	ns
Fall Time	t <sub>f</sub>	Inductive Load	-	110	-	
		I <sub>C</sub> = 75A, V <sub>CC</sub> = 520V				
Reverse Bias Safe Operating Area	RBSOA	$V_P = 650V, V_{GE} = 15V$	FU	LL SQUA	RE	-
		$R_G = 50\Omega, T_j = 175^{\circ}C$				
		V <sub>CC</sub> ≦ 360V				
Short Circuit Withstand Time	$t_{sc}$	V <sub>GE</sub> = 15V	5	-	-	μs
		T <sub>j</sub> = 25°C				

# ●FRD Electrical Characteristics (at T<sub>j</sub> = 25°C unless otherwise specified)

Darameter	Parameter Symbol Conditions	Conditions	Values			Lleit
Parameter		Min.	Тур.	Max.	Unit	
Diode Forward Voltage	V <sub>F</sub>	$I_F = 20A$ $T_j = 25^{\circ}C$ $T_j = 175^{\circ}C$	-	1.45 1.25	1.9 -	V
Diode Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 20A	-	58	-	ns
Diode Peak Reverse Recovery Current	I <sub>rr</sub>	$V_{CC} = 400V$ $di_F/dt = 200A/\mu s$ $T_j = 25^{\circ}C$	-	6.3	-	А
Diode Reverse Recovery Charge	$Q_{rr}$		-	0.20	-	μC
Diode Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 20A	-	256	-	ns
Diode Peak Reverse Recovery Current	I <sub>rr</sub>	$V_{CC} = 400V$ $di_F/dt = 200A/\mu s$ $T_j = 175^{\circ}C$	-	10.4	-	Α
Diode Reverse Recovery Charge	$Q_{rr}$		-	1.35	-	μC

### • Electrical Characteristic Curves

Fig.1 Power Dissipation vs. Case Temperature

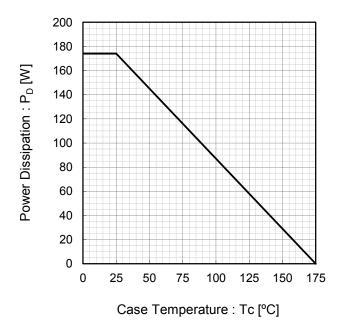


Fig.2 Collector Current vs. Case Temperature

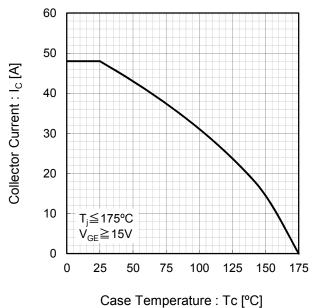


Fig.3 Forward Bias Safe Operating Area

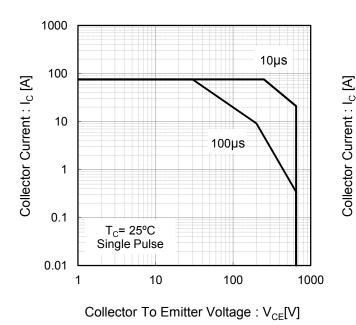
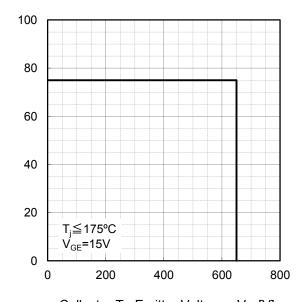


Fig.4 Reverse Bias Safe Operating Area



### Electrical Characteristic Curves

Fig.5 Typical Output Characteristics

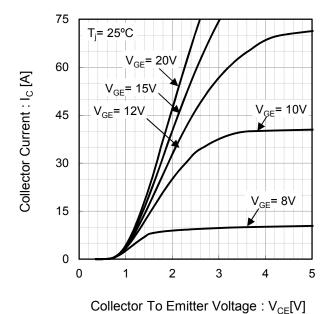
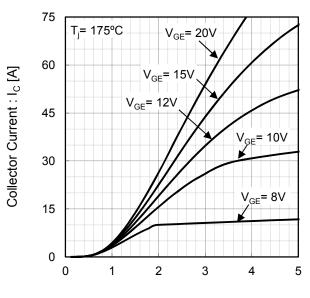


Fig.6 Typical Output Characteristics



Collector To Emitter Voltage : V<sub>CE</sub>[V]

Fig.7 Typical Transfer Characteristics

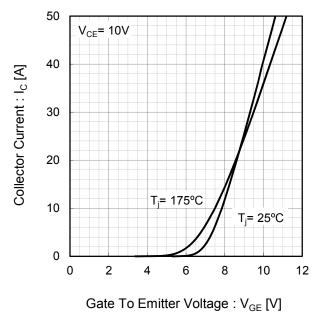
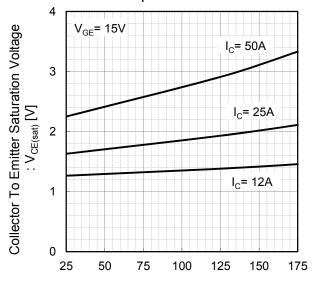


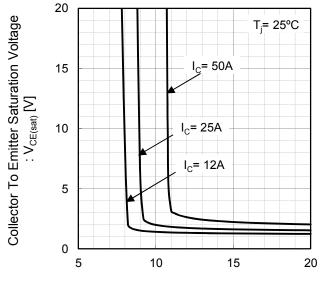
Fig.8 Typical Collector To Emitter Saturation Voltage vs. Junction Temperature



Junction Temperature : T<sub>i</sub> [°C]

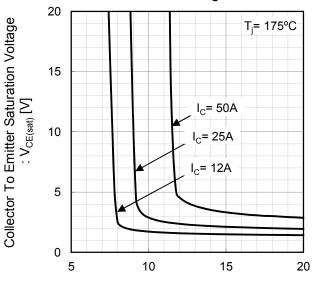
#### Electrical Characteristic Curves

Fig.9 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage



Gate To Emitter Voltage : V<sub>GE</sub> [V]

Fig.10 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage



Gate To Emitter Voltage :  $V_{GE}[V]$ 

Fig.11 Typical Switching Time vs. Collector Current

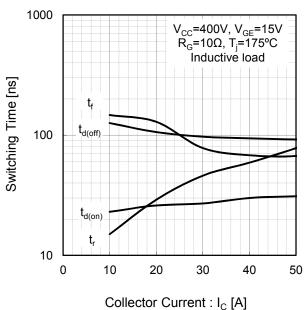
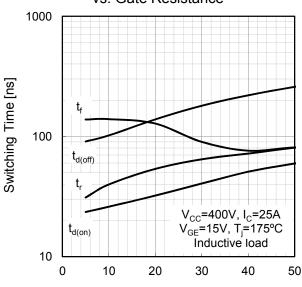


Fig.12 Typical Switching Time vs. Gate Resistance



Gate Resistance :  $R_G[\Omega]$ 

### **•**Electrical Characteristic Curves

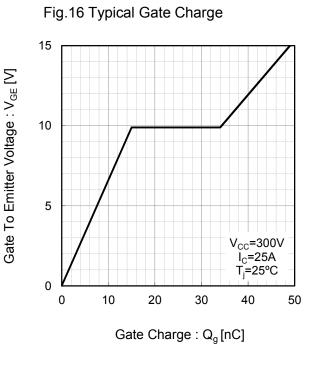
Fig.13 Typical Switching Energy Losses vs. Collector Current 10 Switching Energy Losses [mJ] 1  $\mathsf{E}_{\mathsf{off}}$ 0.1  $\mathsf{E}_{\mathsf{on}}$  $V_{CC}$ =400V,  $V_{GE}$ =15V  $R_{G}$ =10 $\Omega$ ,  $T_{j}$ =175°C Inductive load 0.01 0 10 20 30 40 50 Collector Current : I<sub>C</sub> [A]

vs. Gate Resistance 10 Eoff 1 Eon 0.1 V<sub>CC</sub>=400V, I<sub>C</sub>=25A V<sub>GE</sub>=15V, T<sub>j</sub>=175°C Inductive load 0.01 10 20 40 0 30 50 Gate Resistance :  $R_G[\Omega]$ 

Switching Energy Losses [mJ]

Fig.14 Typical Switching Energy Losses

Fig.15 Typical Capacitance vs. Collector To Emitter Voltage 10000 Cies 1000 Capacitance [pF] 100 Coes Cres 10 f=1MHz V<sub>GE</sub>=0V T<sub>i</sub>=25°C 0.01 0.1 1 10 100 Collector To Emitter Voltage : V<sub>CE</sub>[V]



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### **•**Electrical Characteristic Curves

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Vs. Forward Voltage

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Forward Voltage : V<sub>F</sub>[V]

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Fig.17 Typical Diode Forward Current

Fig.18 Typical Diode Reverse Recovery Time vs. Forward Current 400  $V_{CC}$ =400V di<sub>F</sub>/dt=200A/µs Reverse Recovery Time: t<sub>rr</sub> [ns] Inductive load 300 T<sub>i</sub>= 175°C 200 100 T<sub>i</sub>= 25°C 0 10 20 30 40 50

Fig.19 Typical Diode Reverse Recovery Current vs. Forward Current

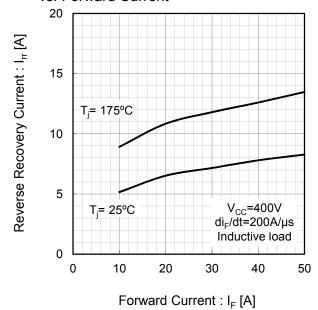
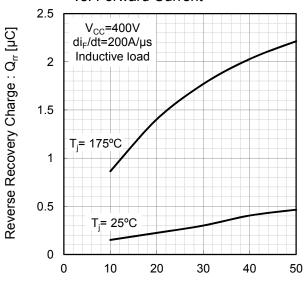


Fig.20 Typical Diode Reverse Recovery Charge vs. Forward Current

Forward Current : I<sub>F</sub> [A]



Forward Current : I<sub>F</sub> [A]

ROHM

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### **•**Electrical Characteristic Curves

Fig.21 IGBT Transient Thermal Impedance

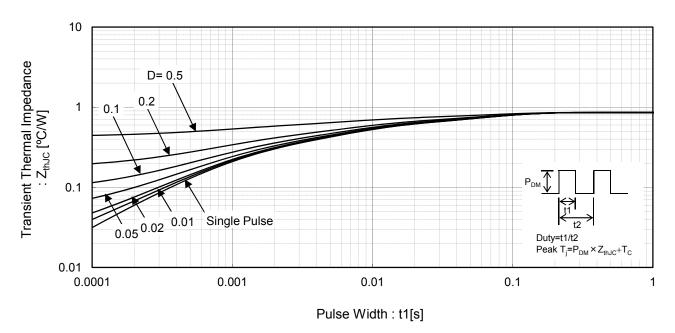
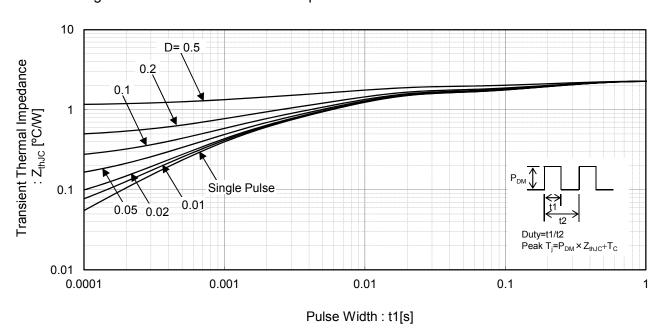


Fig.22 Diode Transient Thermal Impedance



### ●Inductive Load Switching Circuit and Waveform

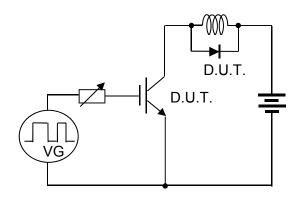


Fig.23 Inductive Load Circuit

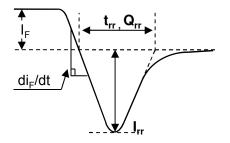


Fig.25 Diode Reverce Recovery Waveform

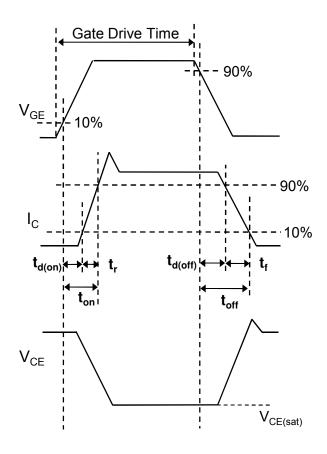


Fig.24 Inductive Load Waveform

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# RGT50TS65D - Web Page

**Distribution Inventory** 

Part Number	RGT50TS65D
Package	TO-247N
Unit Quantity	450
Minimum Package Quantity	450
Packing Type	Bulk
Constitution Materials List	inquiry
RoHS	Yes